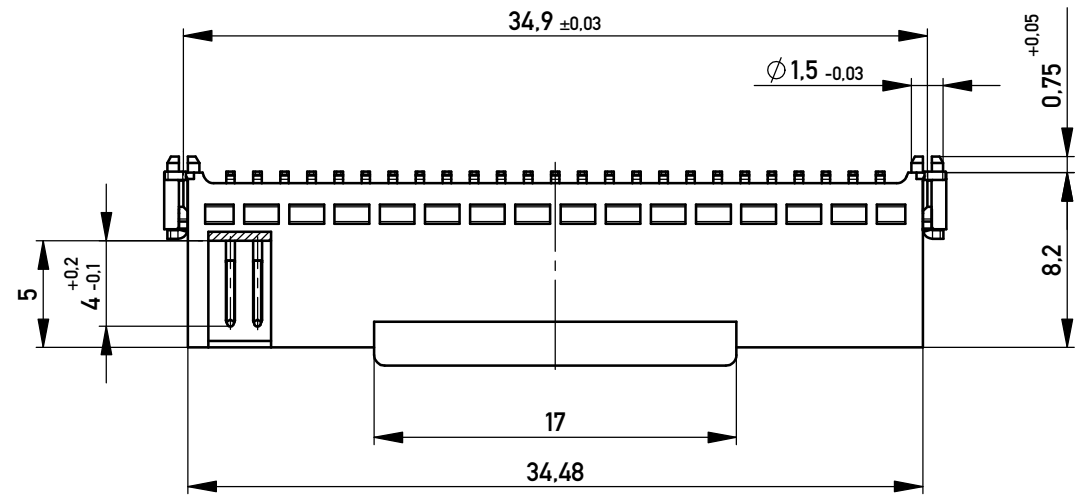
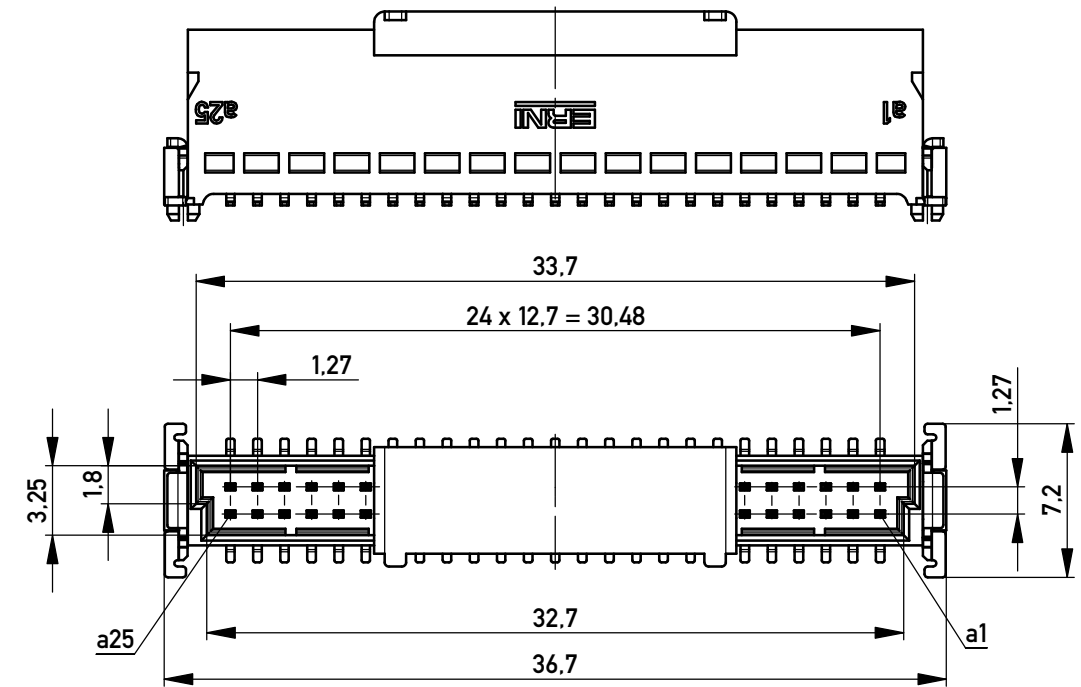
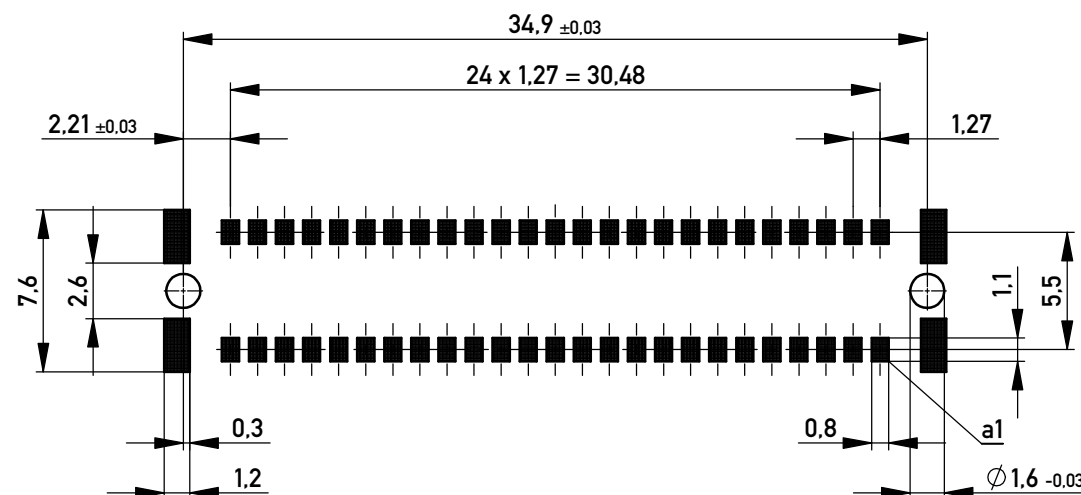




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



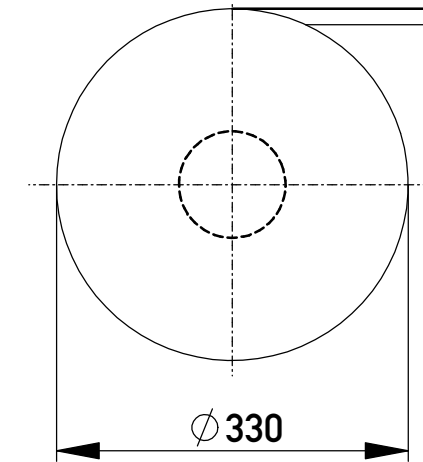
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

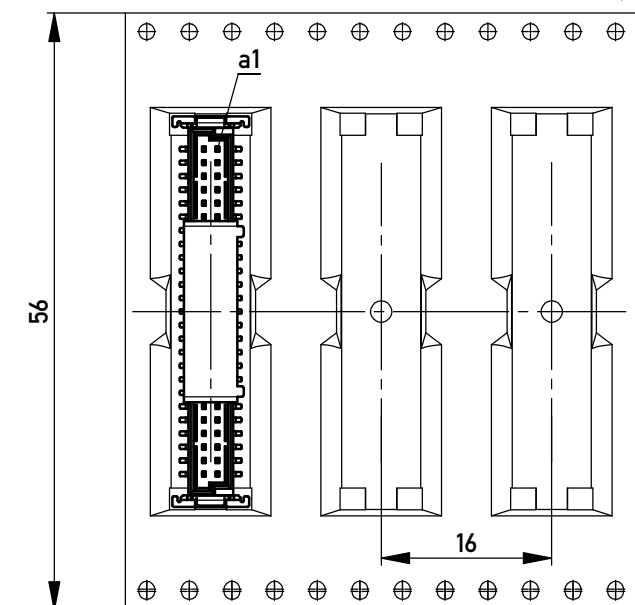
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs

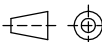


Abspulrichtung - Reel off Direction



BA 3-03 - Standard Bauhöhe
type 3-03 - Standard Assembly Height

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Information:			Tolerances		 All Dimensions in mm		Scale		3:1		
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					Messerl. SMC-Q-50-SMD-BA3-03 <i>Male SMC-Q 50-SMT-type3-03</i>						
			ERNI		www.ERNI.com		063210				I
h		02.07.2015								A3	
Index		Date				Class		SMCQ			

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